

General Description

This product family offers state of the art performance. It is designed for high frequency applications where high efficiency and high reliability are required.

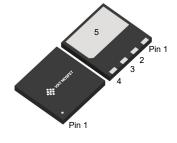
Features

- Low conduction loss due to low VF
- Extremely low switching loss by tiny Qc
- Highly rugged due to better surge current
- Industrial standard quality and reliability

Applications

- UPS
- Power Inverter
- High performance SMPS
- Power factor correction

| Ordering Part Number | Package | Marking | |
|-------------------------|---------|------------|--|
| HC1D06065L | DFN8X8B | HC1D06065L | |



DFN8X8B





Maximum Ratings (at Tc = 25 °C, unless otherwise specified)

| Parameter | Symbol | Value | Unit | |
|--|------------------|-------------|--------|--|
| Repetitive Peak Reverse Voltage | V_{RRM} | 650 | V | |
| Surge Peak Reverse Voltage | V_{RSM} | 650 | V | |
| DC Peak Reverse Voltage | V _R | 650 | V | |
| Continuous Forward Current | | | | |
| $T_C = 25^{\circ}C$ | | 23 | | |
| T _C = 135°C | I _F | 12 | Α | |
| $T_C = 162$ °C | | 6 | | |
| Repetitive Peak Forward Surge Current | | | | |
| $T_C = 25^{\circ}C$, $t_p = 10$ ms,Half Sine Pulse | I _{FRM} | 28 | Α | |
| $T_C = 110^{\circ}C$, $t_p = 10$ ms, H alf Sine Pulse | | 17 | | |
| Non-Repetitive Forward Surge Current | | | | |
| $T_C = 25$ °C, t_p =10ms,Half Sine Pulse | I_{FSM} | 48 | Α | |
| $T_C = 110^{\circ}C$, $t_p = 10$ ms, H alf Sine Pulse | | 43 | | |
| i ² dt value | | | | |
| $T_C = 25$ °C, t_p =10ms,Half Sine Pulse | ∫i²dt | 11.4 | A^2s | |
| $T_C = 110^{\circ}C$, $t_p = 10$ ms,Half Sine Pulse | | 9.1 | | |
| Power dissipation | | | | |
| T _C = 25°C | P _{tot} | 71 | W | |
| $T_C = 110$ °C | | 30 | | |
| Operating junction Range | T _j | -55 to +175 | °C | |
| Storage temperature Range | T _{stg} | -55 to +150 | °C | |

Thermal Resistance

| Parameter | Symbol | Тур. | Unit |
|--------------------------------------|------------|------|------|
| Thermal resistance, junction – case. | R_{thJC} | 2.1 | °C/W |



Electrical Characteristic (at Tc = 25 °C, unless otherwise specified)

| Parameter | Symbol | Value | | | Unit | Test Condition | |
|-------------------------|----------------|-------|------|------|-------|--|--|
| Parameter | Syllibol | min. | typ. | max. | Oilit | Test Condition | |
| | | | | | | I _F =6A | |
| Forward Voltage | V _F | - | 1.3 | 1.5 | V | T _j =25°C | |
| | | - | 1.5 | | | T _j =175°C | |
| | | | | | | V _R =650V | |
| Reverse Current | I _R | - | - | 50 | μΑ | T _j =25°C | |
| | | - | - | 200 | | T _j =175°C | |
| | | | | | nC | V _R =400V,T _j =25℃ | |
| Total Capacitive Charge | Q_{C} | 1 | 18 | - | | $Q_C = \int_0^{V_R} C(V) dV$ | |
| | | | | | | T _j =25℃, f=1MHz | |
| Total Capacitance | С | - | 358 | - | pF | V _R =0V | |
| | | - | 36 | - | | V _R =200V | |
| | | - | 30 | - | | V _R =400V | |

Characteristics Curve

Fig 1: Forward Characteristics

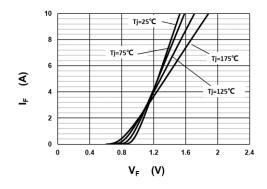


Fig 2: Reverse Characteristics

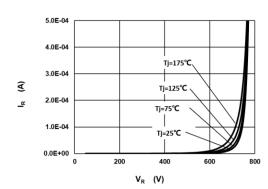


Fig 3: Current Derating

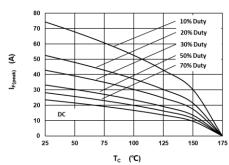


Fig 4: Power Derating

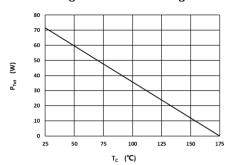


Fig 5: Capacitance vs. Reverse Voltage

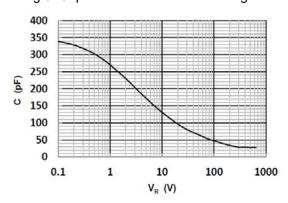


Fig 6: Reverse Charge vs. Reverse Voltage

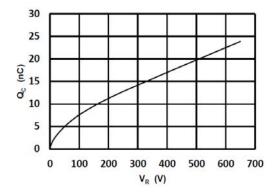
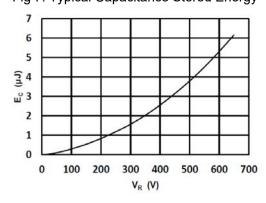


Fig 7: Typical Capacitance Stored Energy



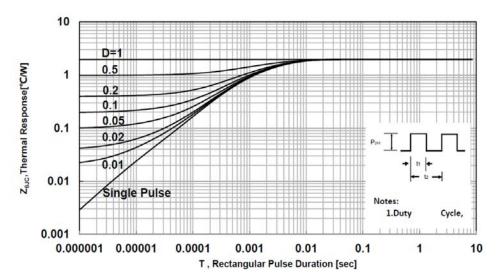
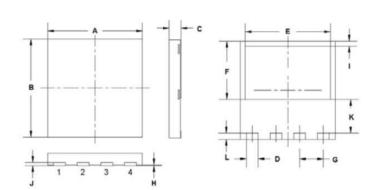


Fig 8: Transient Thermal Impandance

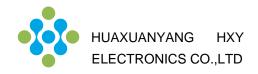
Package Dimensions

Package DFN8X8B



Unit: mm

| Dimension | Min. | Max. |
|-----------|------|------|
| Α | 7.90 | 8.10 |
| В | 7.90 | 8.10 |
| С | 0.75 | 0.95 |
| D | 0.90 | 1.10 |
| E | 7.10 | 7.30 |
| F | 4.65 | 4.85 |
| G | 1.80 | 2.20 |
| Н | 0.00 | 0.05 |
| 1 | 0.30 | 0.50 |
| J | 0.10 | 0.30 |
| K | 2.65 | 2.85 |
| L | 0.40 | 0.60 |



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